



KYUNG NAM PRECISION Co.,Ltd

Kyung Nam Precision Engineering

PCB / Precision Machining

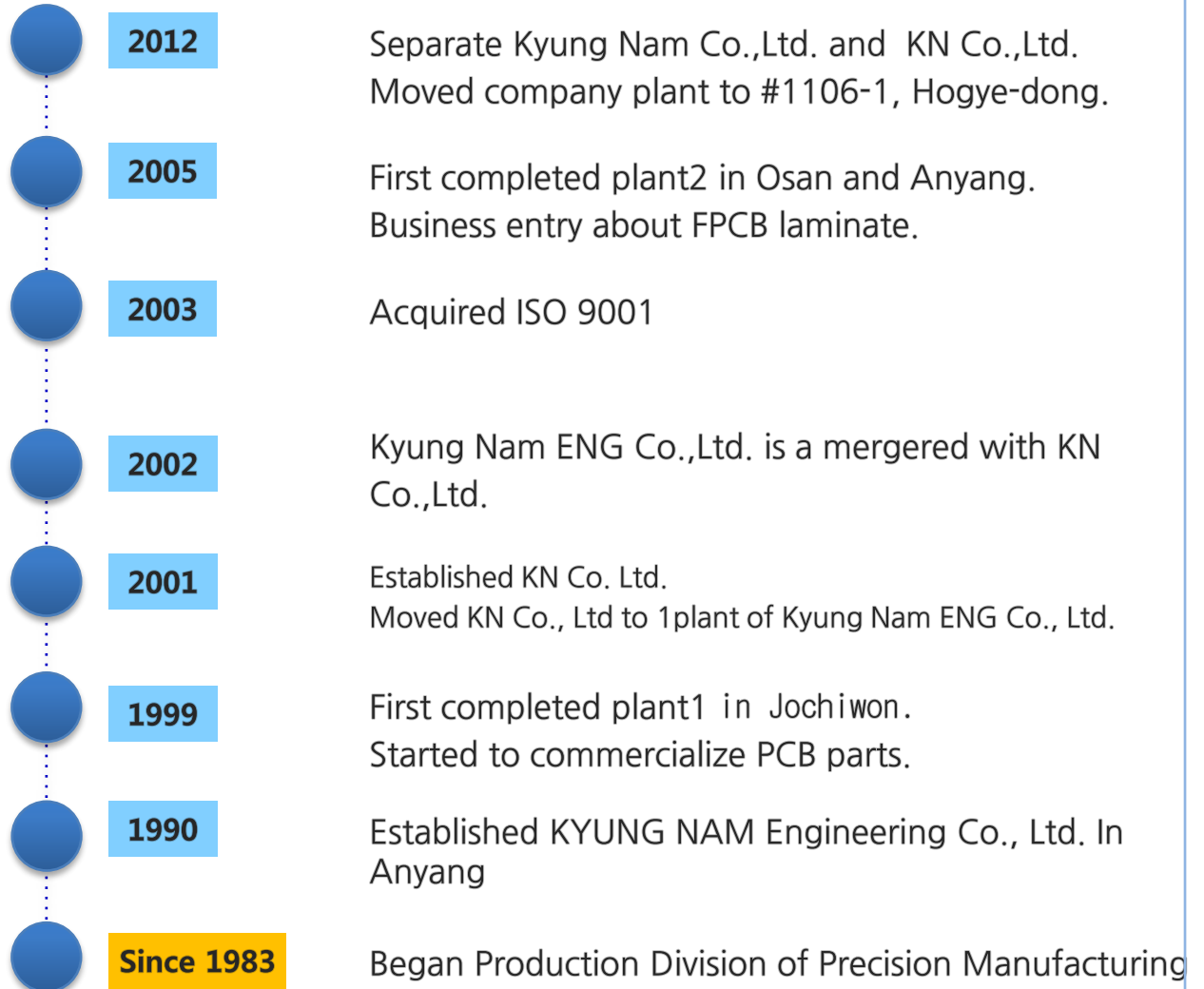




I . INTRODUCTION

Introduction / History

History of Kyung Nam Precision Engineering



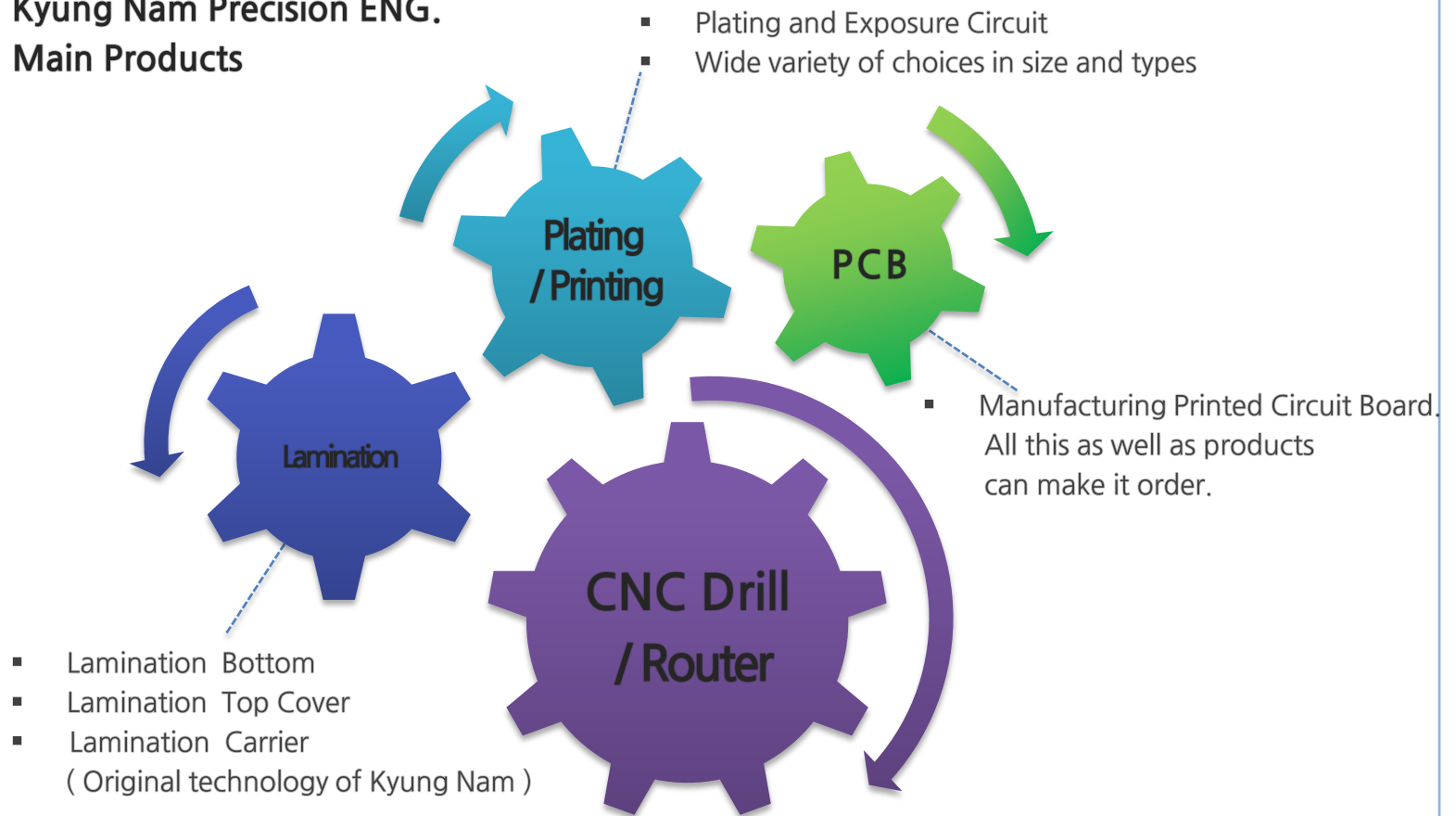


II . FIELD OF BUSINESS

Staple Products



**Kyung Nam Precision ENG.
Main Products**





III. MAIN PRODUCTS

Primary Processed Goods

FRACTION DEFECTIVE - LAMINATION(Hot press) PROCESSING

A

10,000ea per work basis (Result is vary depending on operator and processing)

	Bonding Machine	Circle Guide Pin	Other Rivet	Kyung Nam's Rivet
4 layers	5%	12%	20%	2%
6 layers	4%	16%	24%	2%
8 layers	10%	20%	28%	3%
Up to 10 layers	15%	26%	34%	4%

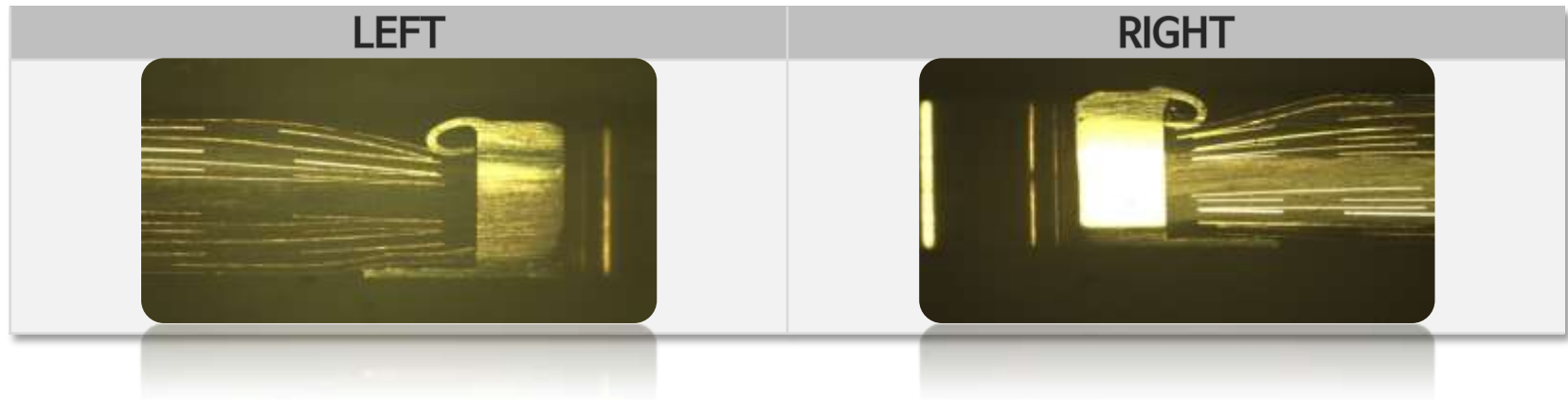
B

10,000ea per work basis (Result is vary depending on operator and processing)

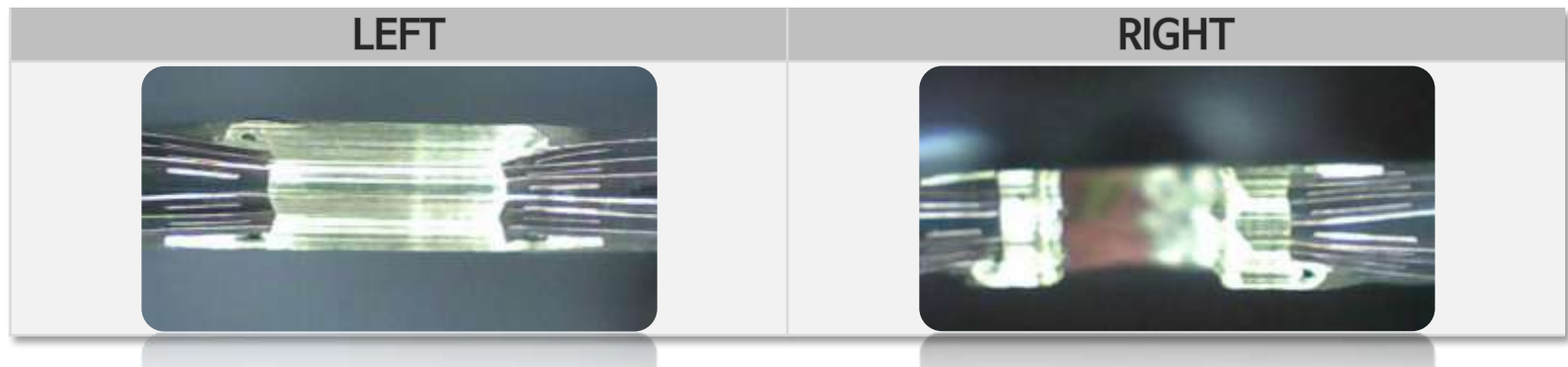
	Bonding Machine	Circle Guide Pin	Other Rivet	Kyung Nam's Rivet
4 layers	4%	10%	18%	3%
6 layers	5%	15%	20%	2%
8 layers	8%	21%	24%	3%
Up to 10 layers	13%	23%	29%	5%

COMPARATIVE LAMINATION ROCESSING RESULT

▶ Using other Rivet

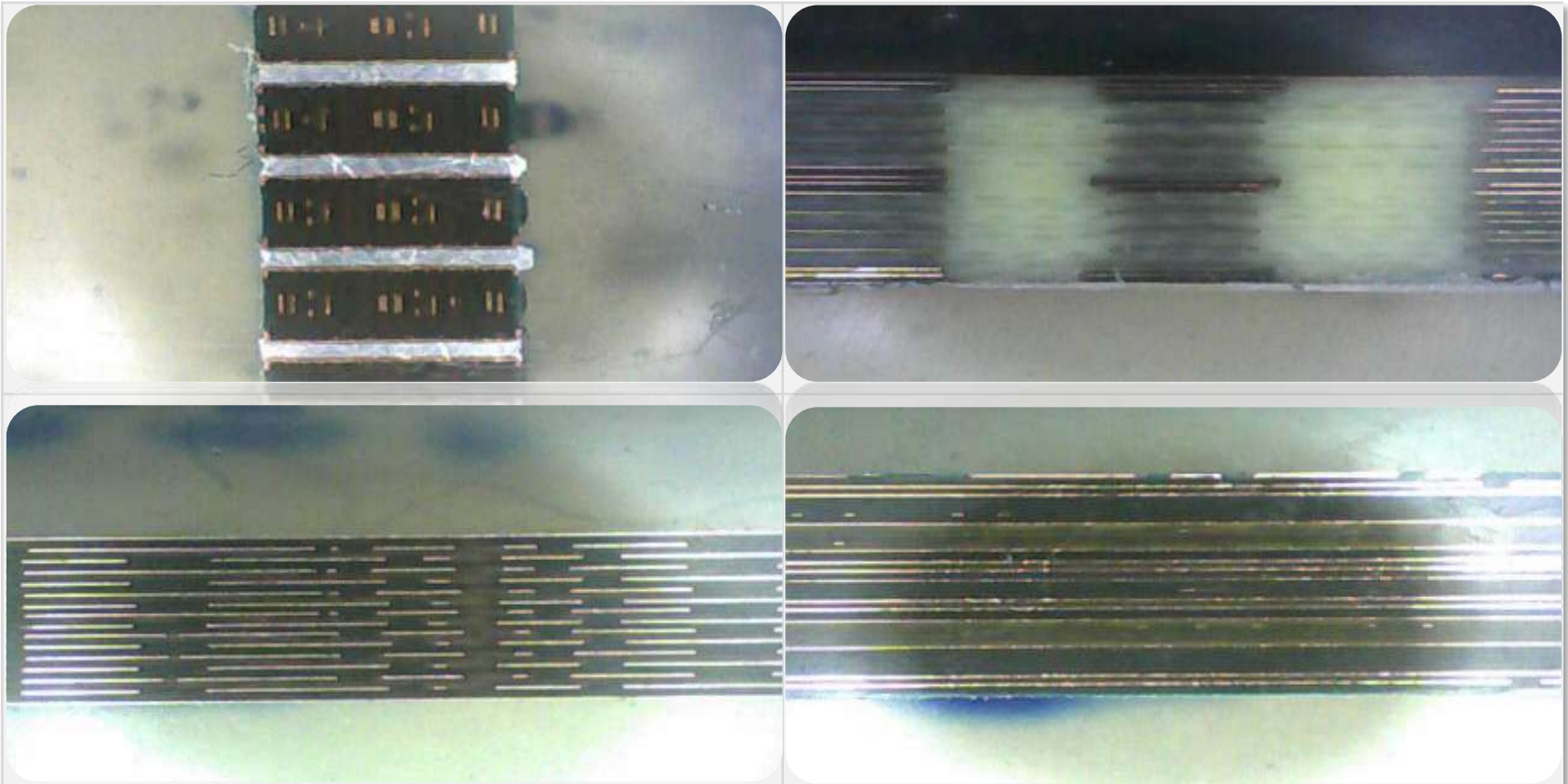


▶ Using Kyung Nam Engineering's Rivet



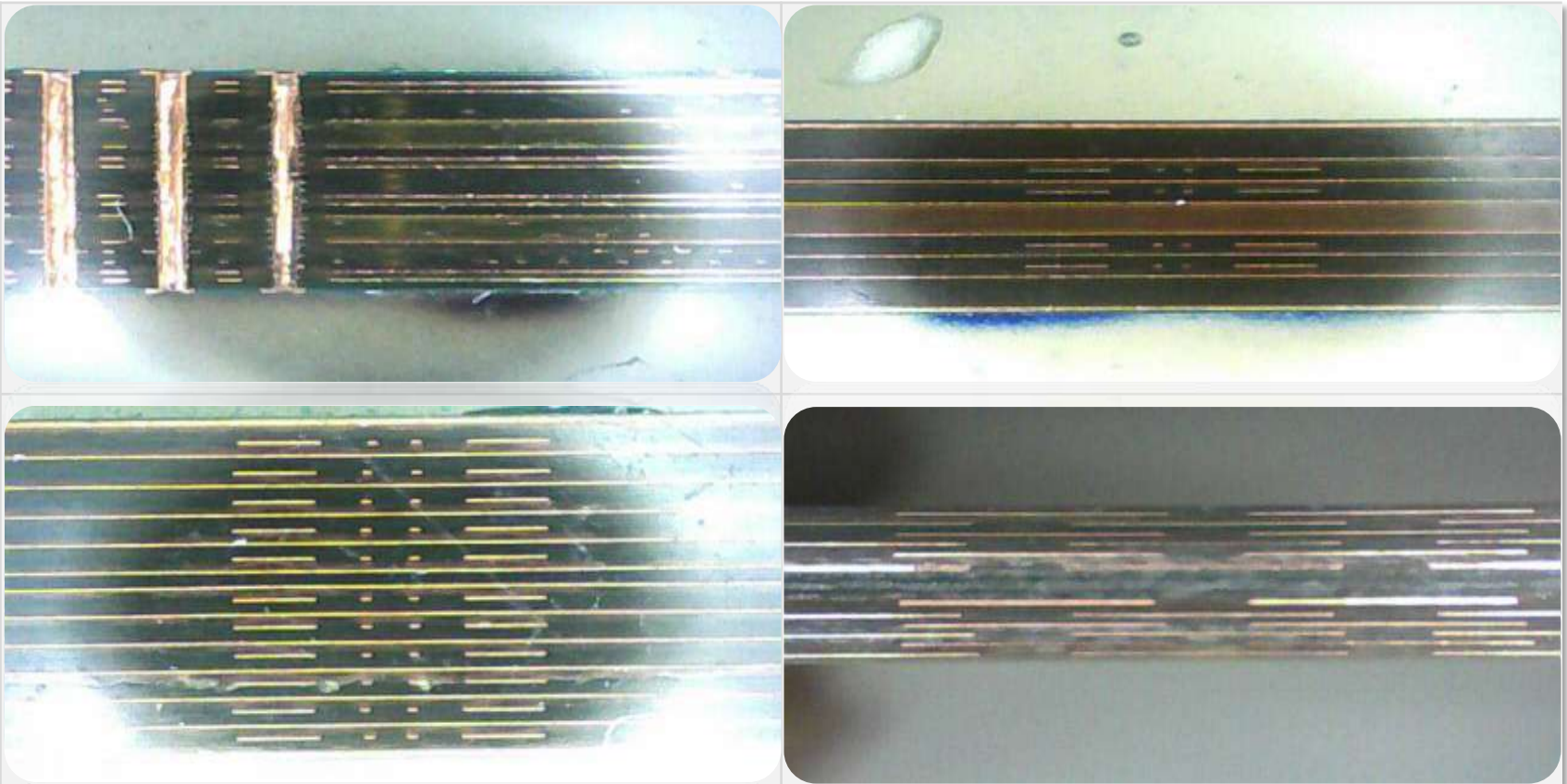
I. LAMINATION CROSS SECTION (Show result of stabilization processing)

► Using Kyung Nam Engineering's Rivet



II. LAMINATION CROSS SECTION (Show result of stabilization processing)

► Using Kyung Nam Engineering's Rivet



III. LAMINATION CROSS SECTION (After hot press processing)

▶ Using Kyung Nam Engineering's Rivet

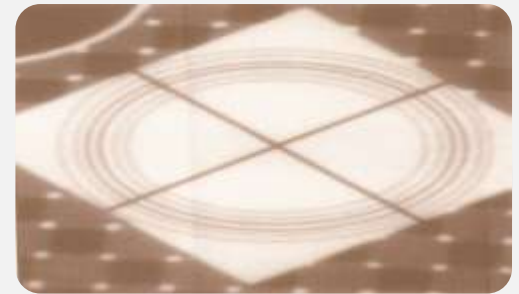
To fix a rivet to the circuit board with melting EPOXY



IV. COMPLETION LAMINATION WORK (Guide and Rivet hole X-Ray picture)

▶ Using Kyung Nam Engineering's Rivet

GUIDE HOLE



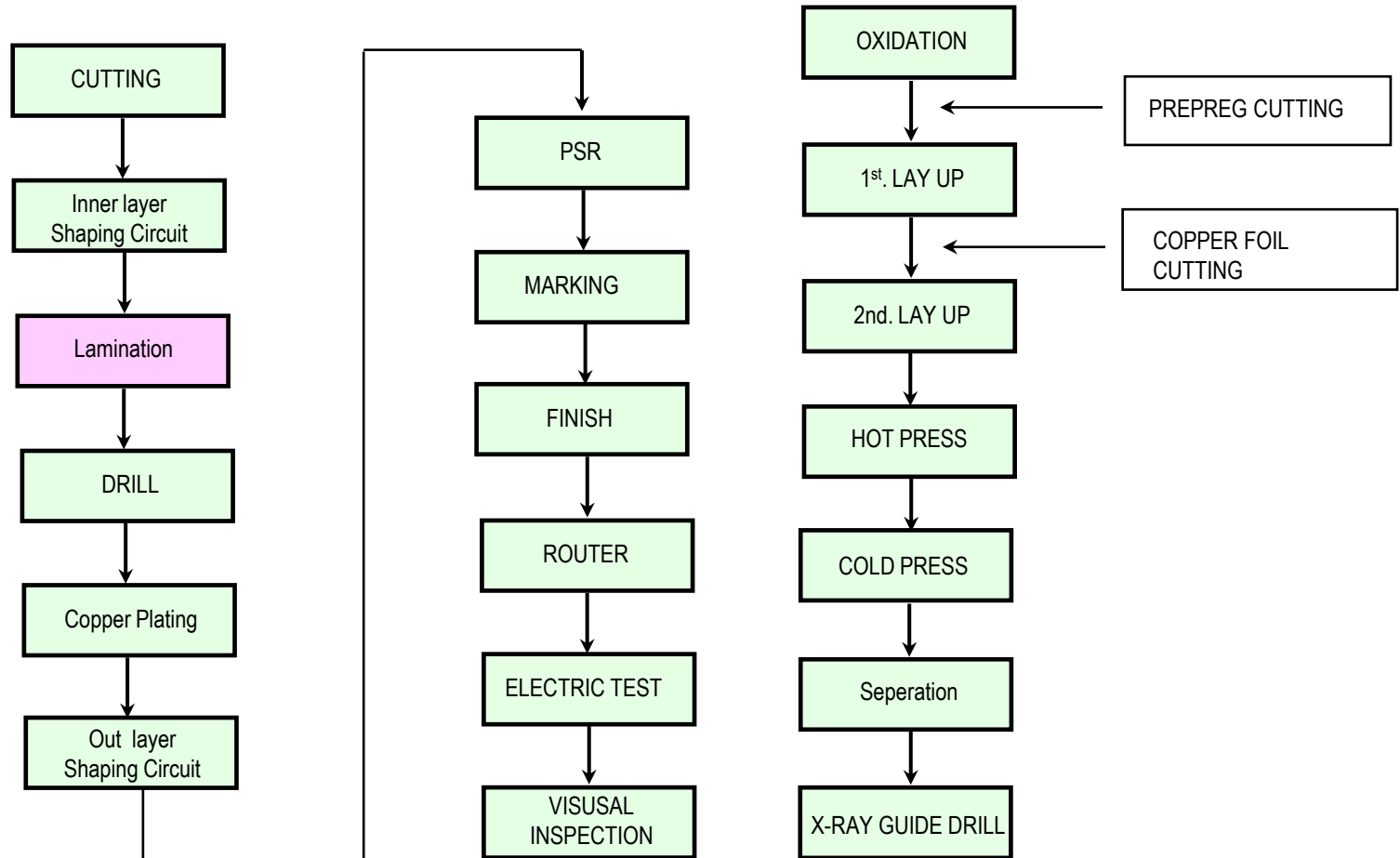
RIVET HOLE



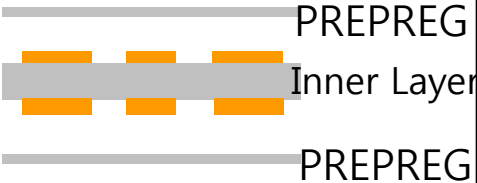
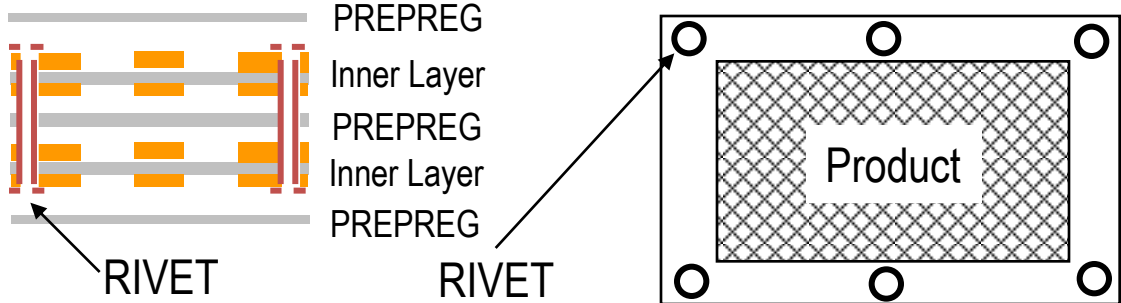
COMPLETION LAMINATION



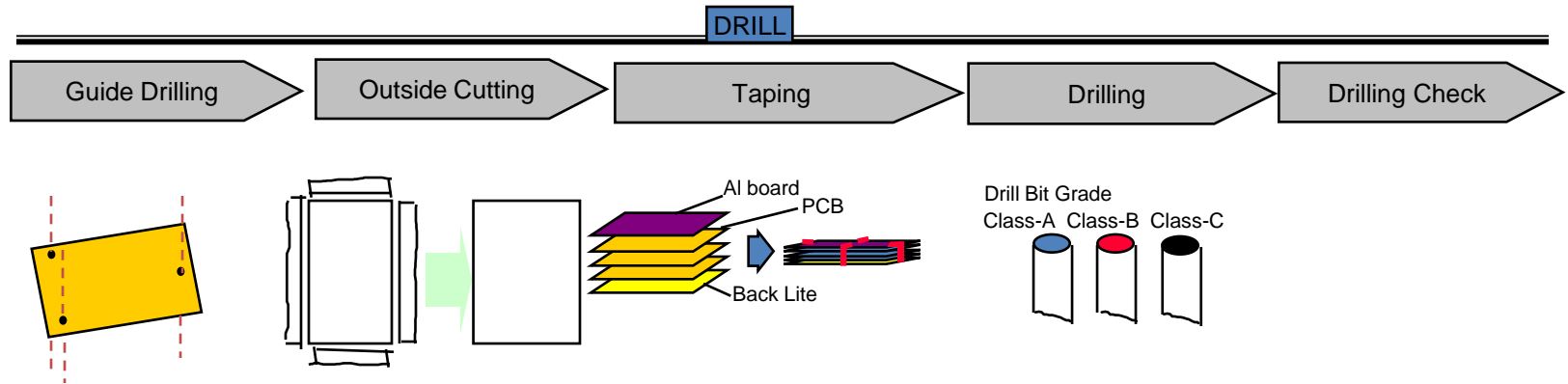
V. PCB Process (MLB PCB)



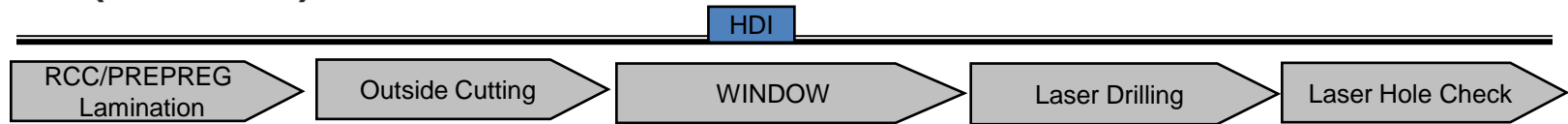
VI. LAY - UP Process (MLB PCB)

4 Layer	Up to 6 Layer
 <p>PREPREG</p> <p>Inner Layer</p> <p>PREPREG</p>	<p>1. RIVET method</p> <p>To fix between layer and layer of up to 4 layer PCB. Registration prevention, Integration of PCB at Press process.</p> <div data-bbox="658 953 1785 1253">  <p>PREPREG</p> <p>Inner Layer</p> <p>PREPREG</p> <p>Inner Layer</p> <p>PREPREG</p> <p>RIVET</p> <p>RIVET</p> <p>Product</p> </div>

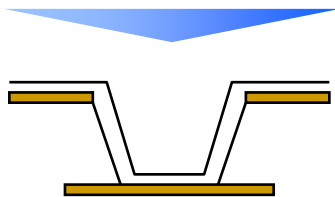
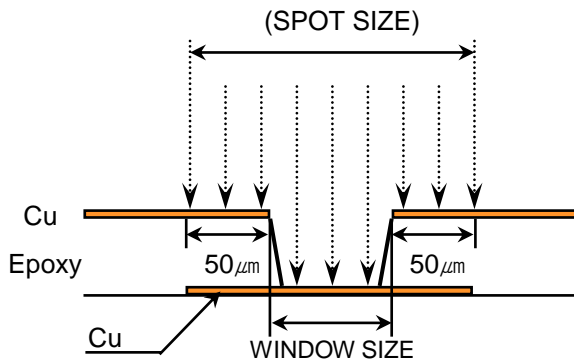
VII. DRILL Process (MLB PCB)



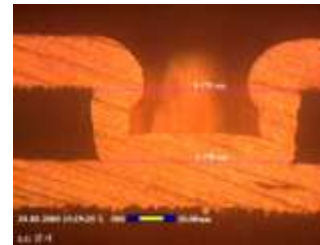
VII. LASER DRILL Process (MLB PCB)



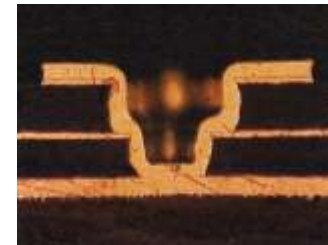
7. LASER DRILL Process (Conformal method)



8. Micro via Hole Type



< SBL >



< MBL >





실용신안등록증

등 록 제 0267678 호

출원 번호 제 2001-0030524 호
출원 일자 2001년 12월 30일
등록 일자 2002년 02월 27일

고안의 명칭 피시비기판의 홀가공장치

실용신안권자 백형열 (591228-1002057)

경기 안양시 만안구 석수2동 417-3 한신아파트 114동 304호

고 안 자 백형열 (591228-1002057)

경기 안양시 만안구 석수2동 417-3 한신아파트 114동 304호

위의 고안은 실용신안법에 의하여 실용신안등록
원부에 등록되었음을 증명합니다.

2002년 02월 27일

특 허 청



이 실용신안권은 실용신안법 제41조에 따라 실용신안법 제23조제2항에 의한 등록특허권과 동등한 법적 효력을 갖는다. 이 실용신안권의 침해에 대해 그 권리를 행사할 수 있습니다.



특 허 증

특 허 제 0460185 호

출원 번호 제 2000-0060013 호
출원 일자 2000년 10월 09일
등록 일자 2004년 11월 29일

발명의 명칭 피시비기판 제조공정에 있어서, 다단식으로 리튬원 원자재고정용 리벳의 가공 체결방법 및 그 장치

특허 권자 백형열 (591228-1002057)

경기 안양시 만안구 호계동 1106-1

발 명 자 백형열 (591228-1002057)

경기 안양시 만안구 호계동 1106-1

위의 발명은 특허법에 의하여 특허등록원부에 등록
되었음을 증명합니다.

2004년 11월 29일

특 허 청



We promise we will be your reliable partner
with our original technology and experience.
Thank you for being with us!

-CEO Mr. Baek-



KYUNG NAM PRECISION Co.

PRECISION MANUFACTURING / RIVET / PIN / JIG / RING

- Add : #1106-1. Hogle-dong, Dongan-gu, Anyang-si,
Gyeonggi-do, Korea
 - Tel : 82 - 31 - 458 - 0507
 - Fax : 82 - 31 - 429 - 0503
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